

DATA SHEET

SKY13453-385LF: 0.01 to 6.0 GHz Single Control SPDT Switch

Applications

- Cellular pre-PA mode switches
- Dual-band WLANs (802.11a/b/g/n)

Features

- Low insertion loss: 0.40 dB @ 2.0 GHz
- High isolation: >25 dB @ 2.0 GHz
- · Single bit control
- Small QFN (6-pin, 1 x 1 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.

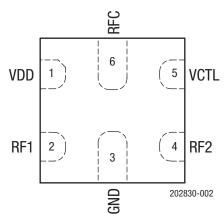


Figure 2. SKY13453-385LF Pinout (Top View)

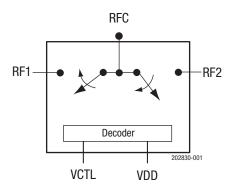


Figure 1. SKY13453-385LF Block Diagram

Description

The SKY13453-385LF is a single-pole, double-throw (SPDT) switch intended for mode switching in pre-power amplifier (PA) cellular or WLAN applications. Using advanced switching technologies, the SKY13453-385LF maintains low insertion loss and high isolation for all switching paths.

The high-linearity performance and low insertion loss achieved by the switch make it an ideal choice for mode switching before the PA in cellular applications. Depending on the logic voltage applied to the control pin (VCTL), the RFC pin is connected to one of the two switched RF outputs, RF1 or RF2, using a low insertion loss path, while the path between the RFC pin and the other RF path is in a high isolation state.

The switch is manufactured in a compact, 1 x 1 mm, 6-pin Quad Flat No-Lead (QFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY13453-385LF Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	VDD	Supply voltage	4	RF2	RF port 2. Must be DC blocked.
2	RF1	RF port 1. Must be DC blocked.	5	VCTL	DC control voltage
3	GND	Ground	6	RFC	RF common port. Must be DC blocked.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY13453-385LF are provided in Table 2. Electrical specifications are provided in Table 3.

The state of the SKY13453-385LF is determined by the logic provided in Table 4. A timing diagram is shown in Figure 3.

The typical performance characteristics for the SKY13453-385LF are shown in Figures 4 through 7.

Table 2. SKY13453-385LF Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	VDD	2.5	3.7	V
Control voltage	VCTL	-0.2	+3.0	V
Input power	Pin		+33	dBm
Storage temperature	Тѕтс	-40	+125	°C
Operating temperature	Тор	-40	+90	°C

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 3. SKY13453-385LF Electrical Specifications 1 (VDD = 2.8 V, VCTL = 1.8 V, 1 Cr = +25 $^{\circ}$ C, 1 Cr = 0 dBm, Characteristic Impedance [Zo] = 50 Ω , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
RF Specifications		•	•			
Insertion loss (RFC to RF1/RF2 ports)	IL	0.01 to 1.0 GHz 1.0 to 2.0 GHz 2.0 to 3.0 GHz 4.8 to 6.0 GHz		0.40 0.40 0.45 0.70	0.55 0.55 0.60 0.85	dB dB dB dB
Isolation (RFC to RF1/RF2 ports)	Iso	0.01 to 1.0 GHz 1.0 to 2.0 GHz 2.0 to 3.0 GHz 4.8 to 6.0 GHz	25 25 22	27 27 24 15		dB dB dB dB
Return loss (RFC to RF1/RF2 ports)	IS11I	0.01 to 3.0 GHz 4.8 to 6.0 GHz		23 29		dB dB
0.1 dB input compression point (RF1/RF2 ports)	IP0.1dB	0.7 to 6.0 GHz		+33		dBm
2 nd harmonics	2fo	PIN = +20 dBm: 0.8 to 2.7 GHz 4.8 to 6.0 GHz	+74 +75	+85 +85		dBc dBc
3 rd harmonics	3fo	PIN = +20 dBm: 0.8 to 2.7 GHz 4.8 to 6.0 GHz	+75 +75	+85 +85		dBc dBc
Third order input intercept point (RF1/RF2)	IIP3	$P_{IN} = +17 \text{ dBm/tone},$ $\Delta f = 1 \text{ MHz}:$ 2.450 GHz, 5.8 GHz	+50 +50	+57 +56		dBm dBm
Error vector magnitude	EVM	802.11a, 54 Mbps, P _{IN} ≤ +27 dBm 802.11g, 54 Mbps,		2.5		%
Switching speed		P _{IN} ≤ +27 dBm ② 2.45 GHz: 50% VCTL to 10/90% RF on time 50% VCTL to 90/10% RF off time 10/90% RF rise time		650 650 500		ns ns ns
DC Specifications		90/10% RF fall time		500		ns
Control voltage:		Note 2				
Low High	Vctl_l Vctl_h	1000 2	0 1.35	1.8	0.45 3.0	V V
Supply voltage	VDD		2.5		3.5	V
Supply current	loo	VDD = 3.7 V		3	10	μΑ
Control current	ICTL	VCTL = 1.8 V		1		μΑ
Leakage control current	I _{CTL_LKG}	VCTL = 1.8 V, VDD = 0 V			0.5	μΑ

¹ Performance is guaranteed only under the conditions listed in this table

² VCTL_H should always be lower than or equal to VDD.

Table 4. SKY13453-385LF Truth Table¹

VDD (Pin 1)	VCTL (Pin 5)	Insertion Loss Path
Н	Н	RFC to RF1
Н	L	RFC to RF2

 $^{^{1}}$ "H" = +1.8 V to +3.0 V. "L" = 0 V to +0.45 V.

Any state other than described in this table places the switch into an undefined state. An undefined state will not damage the device.

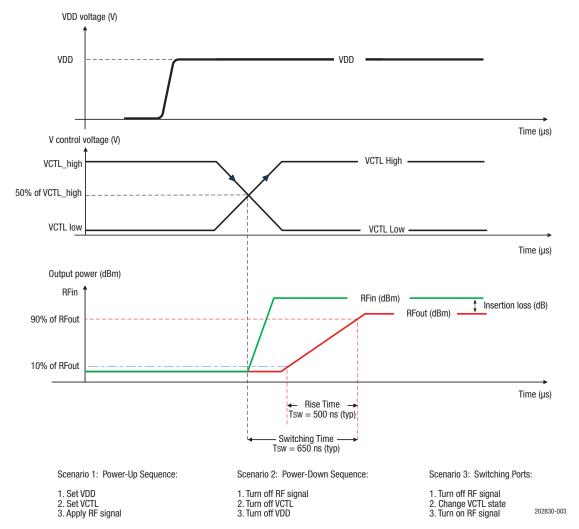
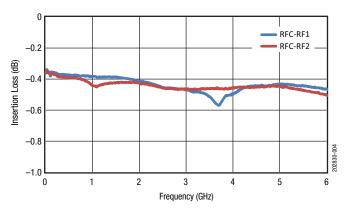


Figure 3. SKY13453-385LF Timing Diagram

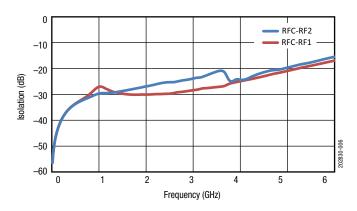
Typical Performance Characteristics (VDD = 2.8 V, VCTL = 1.8 V, TOP = +25 °C, PIN = 0 dBm, Characteristic Impedance [Zo] = 50 Ω , Unless Otherwise Noted)



0 S11_RF1on -10 S11_RF2on -20 Return Loss (dB) -30-40 -50 -60 0 2 3 5 6 Frequency (GHz)

Figure 4. Insertion Loss vs Frequency

Figure 5. Return Loss vs Frequency



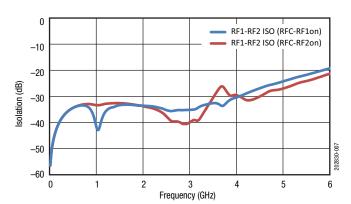


Figure 6. Isolation vs Frequency

Figure 7. Isolation vs Frequency

Evaluation Board Description

The SKY13453-385LF Evaluation Board is used to test the performance of the SKY13453-385LF SP2T Switch. An Evaluation Board schematic diagram is provided in Figure 8. An assembly drawing for the Evaluation Board is shown in Figure 9.

Package Dimensions

The PCB layout footprint for the SKY13453-385LF is provided in Figure 10. Typical part markings are shown in Figure 11. Package dimensions are shown in Figure 12, and tape and reel dimensions are provided in Figure 13.

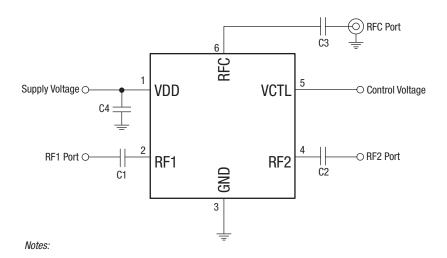
C4 = 10 nF

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY13453-385LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



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Figure 8. SKY13453-385LF Evaluation Board Schematic

C1, C2, and C3 = 10 nF for low frequency applications (less than 100 MHz)

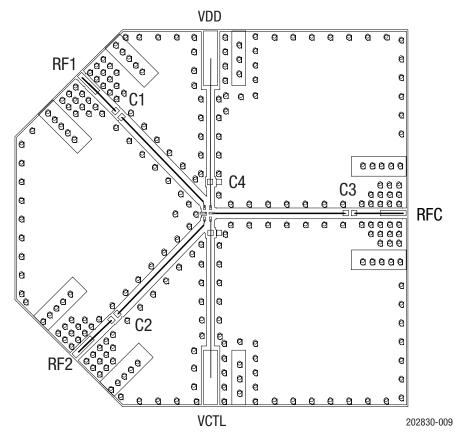


Figure 9. SKY13453-385LF Evaluation Board Assembly Diagram

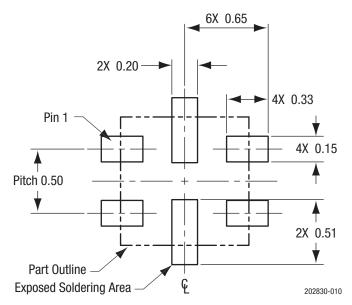


Figure 10. SKY13453-385LF PCB Layout Footprint (Top View)

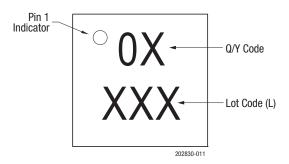
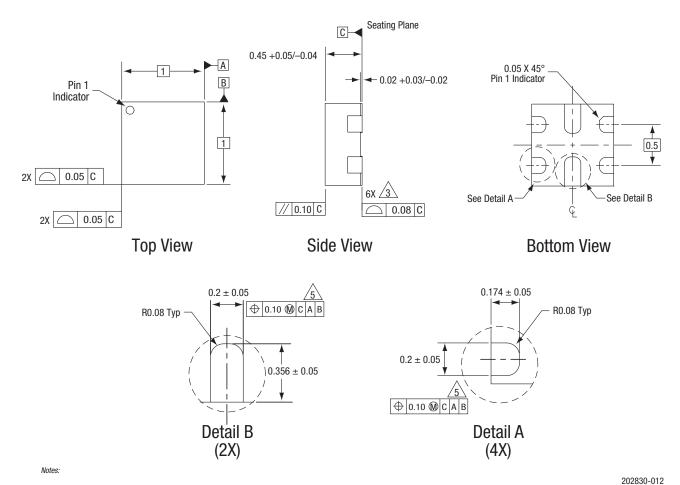
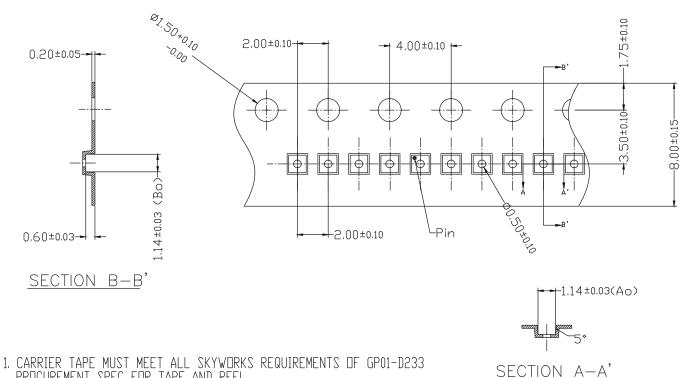


Figure 11. Typical Part Markings (Top View)



- 1. All measurements are in millimeters.
- 2. Dimensions and tolerances according to ASME Y14.5M-1994.

Figure 12. SKY13453-385LF Package Dimensions



- PROCUREMENT SPEC FOR TAPE AND REEL
 2. CARRIER TAPE SHALL BE BLACK CONDUCTIVE POLYCARBONATE.
- 3. COVER TAPE SHALL BE TRANSPARENT CONDUCTIVE MATERIAL
- 4. ESD-SURFACE RESISTIVITY SHALL MEET GP01-D233
- 5. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE : ±0.20mm
- 6. Ao & Bo MEASURED ON PLANE 0.30mm ABOVE THE BOTTOM OF THE POCKET.
- 7. ALL DIMENSIONS ARE IN MILLIMETERS.

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Figure 13. SKY13453-385LF Tape and Reel Dimensions